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## STC6NF30V

N-channel 30V - 0.020Ω - 6A - TSSOP8 2.5V-drive STripFET™ II Power MOSFET

#### **General features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STC6NF30V	30V	< 0.025 Ω (@ 4.5 V) < 0.030 Ω (@ 2.7 V)	6A

- Ultra low threshold gate drive (2.5V)
- Standard outline for easy automated surface mount assembly
- Double dice in common drain configuration



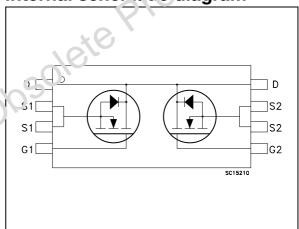
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size<sup>TM</sup>" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance.

### **Applications**

■ Switching application



#### Internal schematic diagram



#### Order code

Part number	Marking	Package	Packaging
STC6NF30V	C6NF30V	TSSOP8	Tape & reel

Contents STC6NF30V

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STC6NF30V **Electrical ratings** 

#### **Electrical ratings** 1

Table 1. **Absolute maximum ratings** 

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	30	V
V <sub>DGR</sub>	Drain-gate voltage ( $R_{GS} = 20K\Omega$ )	20	V
$V_{GS}$	Gate-source voltage	± 12	V
I <sub>D</sub>	Drain current (continuous) at $T_C = 25^{\circ}C$	6	Α
I <sub>D</sub>	Drain current (continuous) at $T_C=100^{\circ}C$	3.8	Α
I <sub>DM</sub> <sup>(1)</sup>	Drain current (pulsed)	24	Α
P <sub>TOT</sub>	Total dissipation at $T_C = 25^{\circ}C$	1.5	W
T <sub>stg</sub>	Storage temperature	-55 to 150	°C
TJ	Max. Operating Junction Temperature	-55 to 150	°C

<sup>1.</sup> Pulse width limited by safe operating area

Table 2. Thermal data

IJ	max. Operating Junction Temperature	-55 to 150	
1. Pulse v	vidth limited by safe operating area		
Table 2.	Thermal data	orodio.	
Symbol	Parameter	Value	Unit
R <sub>thJ-PBC</sub>	Thermal resistance junction-PBC Max	100 (1)	°C/W
R <sub>thJ-PBC</sub>	Thermal resistance junction-PBC Max	83.5 <sup>(2)</sup>	°C/W

<sup>1.</sup> When Mounted on FR-4 board with 1 inch<sup>2</sup> pad, 2 oz. of Cu. and t = 10 sec.

<sup>2.</sup> When Mounted on minimum recommended footprint Obsolete Product(S)

Electrical characteristics STC6NF30V

## 2 Electrical characteristics

(T<sub>J</sub> = 25°C unless otherwise specified)

Table 3. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	30			٧
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS} = Max rating,$ $V_{DS} = Max rating @ 125°C$			1 10	μA μA
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±12V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6			٧
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS}$ = 4.5V, $I_{D}$ = 3A $V_{GS}$ =2.5V, $I_{D}$ = 3A		0.020 0.025	0.025 0.030	$\Omega \ \Omega$

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g <sub>fs</sub> <sup>(1)</sup>	Forward transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> = 6A		18		S
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25V, f = 1 \text{ MHz},$ $V_{GS} = 0$		800 180 32		pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ =15V, $I_{D}$ = 6A $V_{GS}$ = 2.5V Figure 16 on page 9		6.8 2.0 3.4	9	nC nC nC

<sup>1.</sup> Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 5. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$t_{ m d(on)}$ $t_{ m r}$ $t_{ m d(off)}$ $t_{ m f}$	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD}$ = 15V, $I_D$ = 3A, $R_G$ = 4.7 $\Omega$ , $V_{GS}$ = 2.5V Figure 14 on page 9		20 25 32 13		ns ns ns

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current				6	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)				24	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 6A, V_{GS} = 0$			1.2	٧
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 6A, di/dt = 100A/ $\mu$ s, $V_{DD}$ = 15V, $T_{J}$ = 150°C Figure 16 on page 9		25 21 1.7		ns µC A

- 1. Pulse width limited by safe operating area
- 2. Pulsed: pulse duration=300µs, duty cycle 1.5%

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  Obsolete Product(S)

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Electrical characteristics STC6NF30V

# 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

Figure 2. Thermal impedance

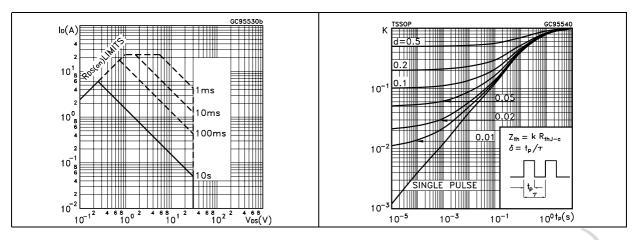


Figure 3. Output characteristics

Figure 4. Transfer characteristics

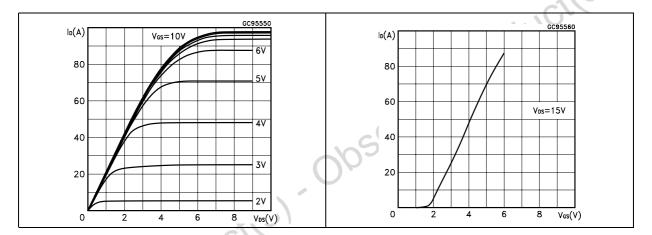


Figure 5. Transconductance

Figure 6. Static drain-source on resistance

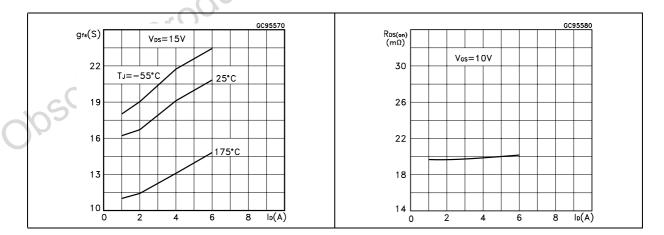


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

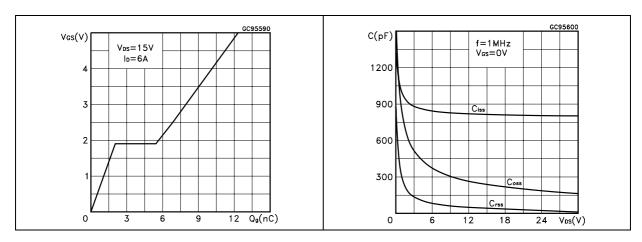


Figure 9. Normalized gate threshold voltage vs. temperature

Figure 10. Normalized on resistance vs. temperature

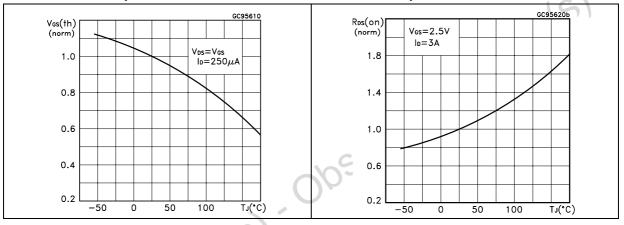
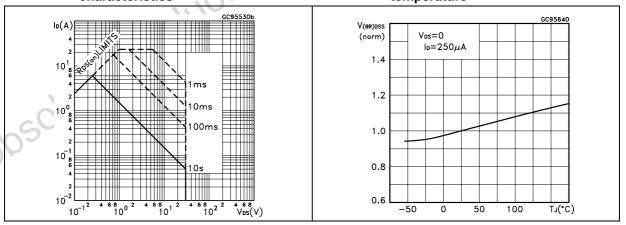


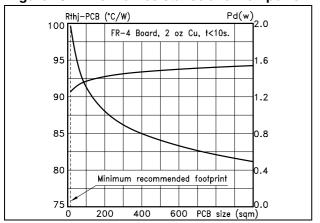
Figure 11. Source-drain diode forward characteristics

Figure 12. Normalized breakdown voltage temperature



Electrical characteristics STC6NF30V

Figure 13. Thermal resistance and max power



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STC6NF30V **Test circuit** 

#### 3 **Test circuit**

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

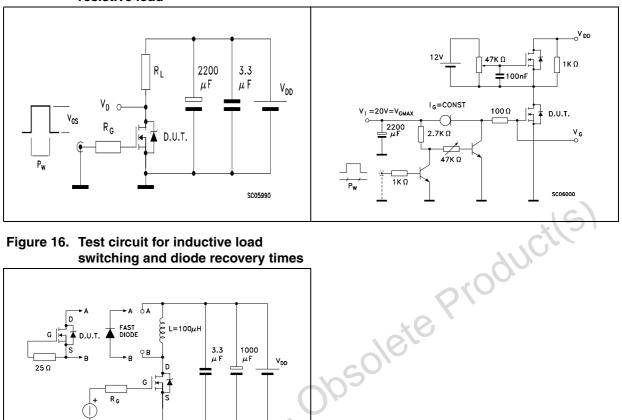
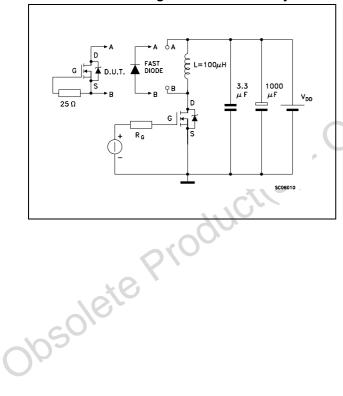


Figure 16. Test circuit for inductive load switching and diode recovery times



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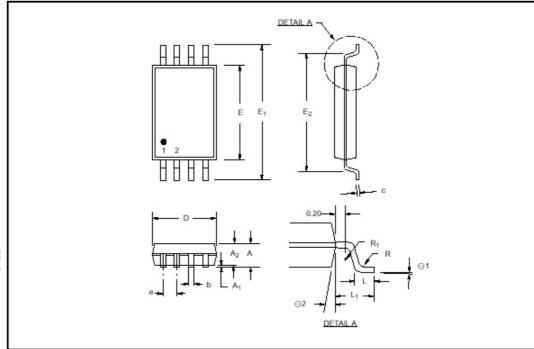
### 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

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## TSSOP8 MECHANICAL DATA

DIM.		mm.			inch	
DIW.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	1.05		1.20	0.041		0.047
A1	0.05		0.15	0.002		0.006
A2	0.80		1.05	0.032		0.041
b	0.19		0.30	0.008		0.012
С		0.127			0.005	
D	2.90		3.10	0.114		0.122
Е	4.30		4.50	0.170		0.177
E1	6.20		6.60	0.240		0.260
E2	5.14		5.24	0.202		0.206
е		0.65			0.025	
L	0.45		0.75	0.018		0.030
L1	0.90		1.10	0.0355		0.0433
R	0.09			0.004		
R1	0.09			0.004		
θ1	0°		8°	O°		8°
92		•	1	2°		



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Revision history STC6NF30V

# 5 Revision history

Table 7. Revision history

Date	Revision	Changes
21-Jun-2004	2	Complete document
03-Aug-2006	3	The document has been reformatted, SOA updated
01-Feb-2007	4	Typo mistake on first page



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